RDK-Value-SB (RevA)

I2C BUS
- SCL
- SDA

BOARD TO BOARD
- IR_Data
- +3.3V

OR

RIBBON CABLE
- Reset-Button
- TO MSP430

LED BOARD
- TO SYSTEM RESET

Reset-Button
- TO MSP430

IR_Data
- TO MSP430

MARCH 23, 2011
HUI LI 6524859 RDK-Value-SB_RevA.sbk

Texas Instruments

PAGE INFO: SATELLITE - LED BOARD
DESIGN LEAD HUI LI
DATE MARCH 23, 2011
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